



Material Content Data Sheet



Sales Product Name		IKW30N60H3		Issued		19. January 2018		
MA#		MA001620198						
Package		PG-TO247-3-41		Weight*		6047.38 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	0.871	0.01	0.01	144	144
chip_2	inorganic material	silicon	7440-21-3	3.012	0.05	0.05	498	498
leadframe	inorganic material	phosphorus	7723-14-0	0.159	0.00		26	
	non noble metal	iron	7439-89-6	0.530	0.01		88	
	non noble metal	copper	7440-50-8	529.068	8.75	8.76	87487	87601
	non noble metal	aluminium	7429-90-5	7.785	0.13	0.13	1287	1287
wire	non noble metal	aluminium	7429-90-5	7.785	0.13	0.13	1287	1287
encapsulation	organic material	carbon black	1333-86-4	19.996	0.33		3307	
	plastics	epoxy resin	-	379.933	6.28		62826	
	inorganic material	silicondioxide	60676-86-0	1599.717	26.45	33.06	264530	330663
leadfinish	non noble metal	tin	7440-31-5	31.874	0.53	0.53	5271	5271
plating	non noble metal	nickel	7440-02-0	29.065	0.48	0.48	4806	4806
solder	non noble metal	antimony	7440-36-0	0.289	0.00		48	
	noble metal	silver	7440-22-4	0.723	0.01		120	
	non noble metal	tin	7440-31-5	1.880	0.03	0.04	311	479
heatspreader	inorganic material	phosphorus	7723-14-0	1.033	0.02		171	
	non noble metal	iron	7439-89-6	3.442	0.06		569	
	non noble metal	copper	7440-50-8	3438.006	56.86	56.94	568511	569251
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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